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**Soft Magnetic Materials:  
Synthesis, Characterization,  
and Applications**



# Journal of MATERIALS RESEARCH

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# Journal of MATERIALS RESEARCH

Volume 33, Number 15, August 13, 2018

## SOFT MAGNETIC MATERIALS: SYNTHESIS, CHARACTERIZATION, AND APPLICATIONS

- 2119 **Introduction**  
Todd C. Monson,  
Josefina Silveyra, Enzo Ferrara,  
Mitra Taheri, Torbjörn Thiringer

## REVIEW

- 2120–2137 **Characterization and assessment of the wideband magnetic properties of nanocrystalline alloys and soft ferrites**  
Enzo Ferrara, Fausto Fiorillo,  
Cinzia Beatrice, Samuel Dobák,  
Carlo Ragusa, Alessandro Magni,  
Carlo Appino

## ARTICLES

- 2138–2147 **Finite element analysis modeling of high voltage and frequency 3-phase solid state transformers enabled by metal amorphous nanocomposites**  
Mst Nazmunnahar, Satoru Simizu,  
Paul R. Ohodnicki,  
Subhashis Bhattacharya,  
Michael E. McHenry
- 2148–2155 **Effect of annealing on magnetic properties of Ni–Mn–Ga glass-coated microwires**  
Arcady Zhukov, Mihail Ipatov,  
Juan J. del Val, Paula Corte-León,  
Julian Gonzalez,  
Alexandr Granovsky,  
Valentina Zhukova
- 2156–2167 **Gram scale synthesis of Fe/Fe<sub>x</sub>O<sub>y</sub> core–shell nanoparticles and their incorporation into matrix-free superparamagnetic nanocomposites**  
John Watt, Grant C. Bleier,  
Zachary W. Romero,  
Bradley G. Hance,  
Jessica A. Bierner,  
Todd C. Monson, Dale L. Huber
- 2168–2175 **Equal channel angular extrusion for bulk processing of Fe–Co–2V soft magnetic alloys, part I: Processing and mechanical properties**  
Don F. Susan, Taymaz Jozaghi,  
Ibrahim Karaman, Jeff M. Rodelas
- 2176–2188 **Equal channel angular extrusion for bulk processing of Fe–Co–2V soft magnetic alloys, part II: Texture analysis and magnetic properties**  
Andrew B. Kustas,  
Joseph R. Michael, Don F. Susan,  
Ibrahim Karaman, Taymaz Jozaghi
- 2189–2206 **Thermal profile shaping and loss impacts of strain annealing on magnetic ribbon cores**  
Richard Beddingfield,  
Subhashish Bhattacharya,  
Kevin Byerly, Satoru Simizu,  
Alex Leary, Mike McHenry,  
Paul Ohodnicki
- 2207–2213 **Assessment of Fe–Ga–B alloy magnetomechanical behavior**  
Cristina Bormio-Nunes,  
Fábio Martins Cardoso
- 2214–2222 **Influence of heat treatment on microstructure, mechanical behavior, and soft magnetic properties in an fcc-based Fe<sub>29</sub>Co<sub>28</sub>Ni<sub>29</sub>Cu<sub>7</sub>Ti<sub>7</sub> high-entropy alloy**  
Zhiqiang Fu,  
Benjamin E. MacDonald,  
Todd C. Monson, Baolong Zheng,  
Weiping Chen, Enrique J. Lavernia
- 2223–2233 **Finite element modeling of nanoscale-enabled microinductors for power electronics**  
Eric D. Langlois, Todd C. Monson,  
Dale L. Huber, John Watt